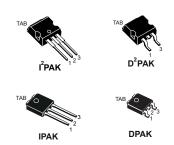
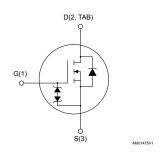


STB4NK60Z-1, STB4NK60ZT4 STD4NK60Z-1, STD4NK60ZT4

Datasheet

N-channel 600 V, 1.7 Ω typ., 4 A SuperMESH™ Power MOSFETs in I²PAK, D²PAK, IPAK and DPAK packages





Product status	
STB4NK60Z-1	
STB4NK60ZT4	
STD4NK60Z-1	

STD4NK60ZT4

Features

Order codes	V _{DS}	R _{DS(on)} max.	P _{TOT}	l _D
STB4NK60Z-1				
STB4NK60ZT4	000.1/	2.0	70 W	4 A
STD4NK60Z-1	600 V	2 Ω	70 VV	4 A
STD4NK60ZT4				

- Extremely high dv/dt capability
- 100% avalanche tested
- · Gate charge minimized
- · Zener-protected

Applications

· Switching applications

Description

These high-voltage devices are Zener-protected N-channel Power MOSFETs developed using the SuperMESH™ technology by STMicroelectronics, an optimization of the well-established PowerMESH™. In addition to a significant reduction in on-resistance, these devices are designed to ensure a high level of dv/dt capability for the most demanding applications.



1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	600	V
V _{GS}	Gate-source voltage	±30	V
I _D	Drain current (continuous) at T _C = 25 °C	4	Α
I _D	Drain current (continuous) at T _C = 100 °C	2.5	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	16	Α
P _{TOT}	Total dissipation at T _C = 25 °C	70	W
ESD	Gate-source human body model (C=100 pF, R=1.5 kΩ)	3	kV
dv/dt (2)	Peak diode recovery voltage slope	4.5	V/ns
Tj	Operating junction temperature range	-55 to 150	°C
T _{stg}	Storage temperature range	-55 (0 150	C

^{1.} Pulse width limited by safe operating area.

Table 2. Thermal data

Combal		Value	l lmi4		
	Symbol	Parameter	I ² PAK, D ² PAK	IPAK, DPAK	Unit
ſ	R _{thj-case}	Thermal resistance junction- case	1.79		°C/W
	R _{thj-amb}	Thermal resistance junction-ambient	62.5	100	°C/W

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by T_j max)	4	Α
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	120	mJ

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^{2.} $I_{SD} \le 4$ A, $di/dt \le 200$ A/ μ s, $V_{DD} \le V_{(BR)DSS}$.



2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V _{GS} = 0 V, I _D = 1 mA	600			V
		V _{GS} = 0 V, V _{DS} = 600 V			1	μA
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V},$ $T_C = 125 ^{\circ}\text{C}^{(1)}$			50	μA
I _{GSS}	Gate-body leakage current	V _{DS} = 0 V, V _{GS} = ±20 V			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 50 \mu A$	3	3.75	4.5	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10 V, I _D = 2 A		1.7	2	Ω

^{1.} Defined by design, not subject to production test.

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance	V _{DS} = 25 V, f = 1 MHz,		510		
C _{oss}	Output capacitance	$V_{DS} = 25 \text{ V}, 1 - 1 \text{ Wiriz},$ $V_{GS} = 0 \text{ V}$	-	67		"F
C _{rss}	Reverse transfer capacitance	VGS - 0 V		13		pF
Coss eq. (1)	Equivalent output capacitance	V _{GS} = 0 V, V _{DS} = 0 V to 480 V	-	38.5		
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 2 \text{ A}, R_G = 4.7 \Omega,$		12		
t _r	Rise time	$V_{GS} = 10 \text{ V}$		9.5		
t _{d(off)}	Turn-off delay time	(see Figure 13. Test circuit for		29		
t _f	Fall time	resistive load switching times)	_	16.5		ns
$t_{r(Voff)}$	Off-voltage rise time	V _{DD} = 480 V, I _D = 4 A,		12		
t _r	Fall time	$R_G = 4.7 \Omega, V_{GS} = 10 V$		12		
t _c	Cross-over time	- (see Figure 15. Test circuit for inductive load switching and diode recovery times)		19.5		
Qg	Total gate charge	V _{DD} = 480 V, I _D = 4 A,		18.8	26	
Q _{gs}	Gate-source charge	V _{GS} = 0 to 10 V	_	3.8		nC
Q_{gd}	Gate-drain charge	(see Figure 14. Test circuit for gate charge behavior)		9.8		

^{1.} $C_{\text{oss eq.}}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

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Table 6. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		4	Α
I _{SDM}	Source-drain current (pulsed)		-		16	A
V _{SD}	Forward on voltage	I _{SD} = 4 A, V _{GS} = 0 V	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 4 A, di/dt = 100 A/μs	-	400		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 24 V, T _j = 150 °C	-	1.7		μC
I _{RRM}	Reverse recovery current	(see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	8.5		Α

Table 7. Gate-source Zener diode

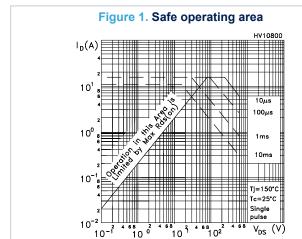
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)GSO}	Gate-source breakdown voltage	I _{GS} = ±1 mA, I _D = 0 A	±30	-	-	V

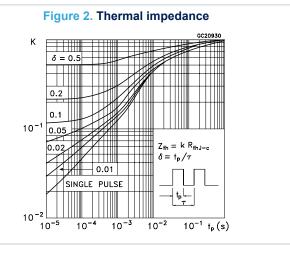
The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

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2.1 Electrical characteristics (curves)





HV10820

8

Ves=10V

7V

6

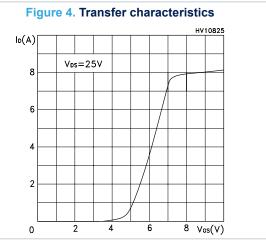
8V

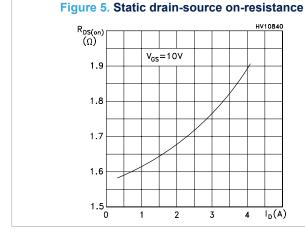
6V

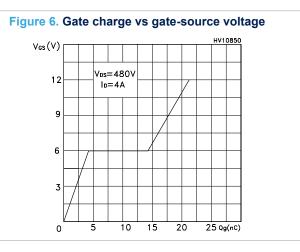
5٧

Vps(V)

Figure 3. Output characterisics







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Figure 7. Capacitance variations

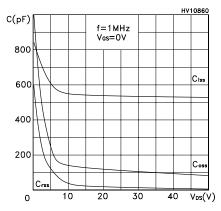


Figure 8. Normalized gate threshold voltage vs temperature

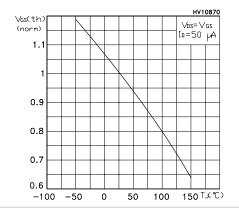


Figure 9. Normalized on-resistance vs temperature

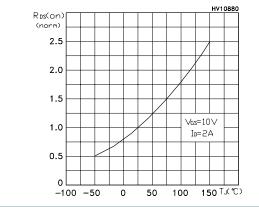


Figure 10. Source-drain diode forward characteristic

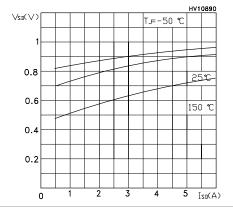


Figure 11. Normalized V_{(BR)DSS} vs temperature

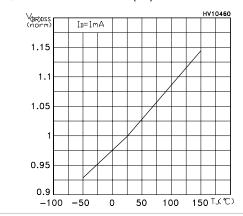
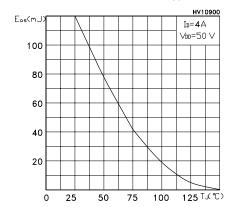


Figure 12. Maximum avalanche energy vs temperature



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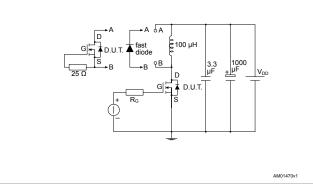


3 Test circuits

Figure 13. Test circuit for resistive load switching times

Figure 14. Test circuit for gate charge behavior

Figure 15. Test circuit for inductive load switching and diode recovery times



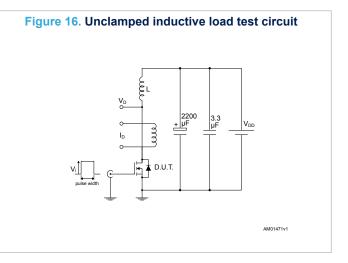


Figure 17. Unclamped inductive waveform

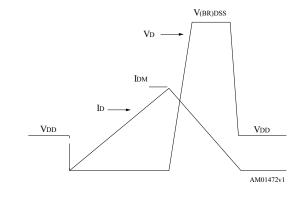
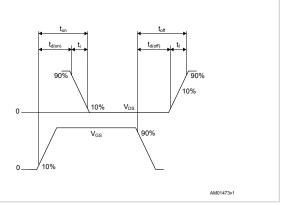


Figure 18. Switching time waveform



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4 Package information

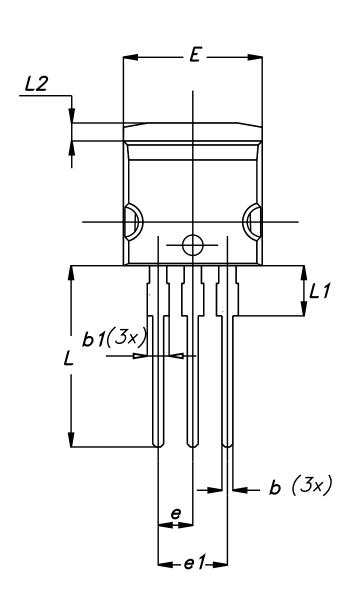
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

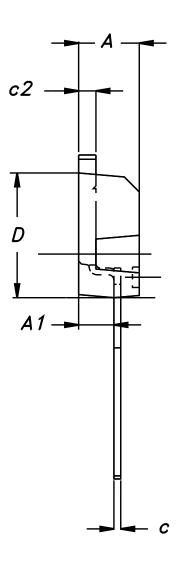
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4.1 I²PAK package information

Figure 19. I²PAK package outline





0004982_Rev_H

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Table 8. I²PAK package mechanical data

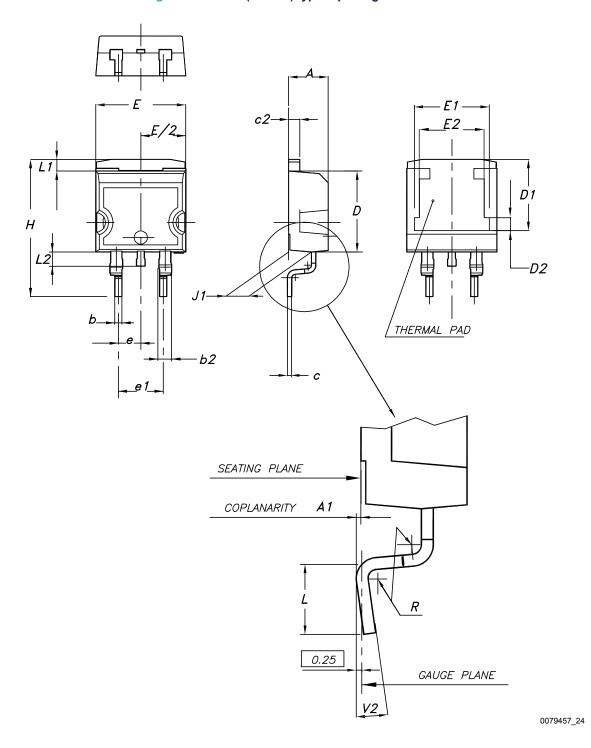
Dim.		mm	
Dilli.	Min.	Тур.	Max.
Α	4.40	-	4.60
A1	2.40	-	2.72
b	0.61	-	0.88
b1	1.14	-	1.70
С	0.49	-	0.70
c2	1.23	-	1.32
D	8.95	-	9.35
е	2.40	-	2.70
e1	4.95	-	5.15
E	10	-	10.40
L	13	-	14
L1	3.50	-	3.93
L2	1.27	-	1.40

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4.2 D²PAK (TO-263) type A package information

Figure 20. D²PAK (TO-263) type A package outline



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Table 9. D²PAK (TO-263) type A package mechanical data

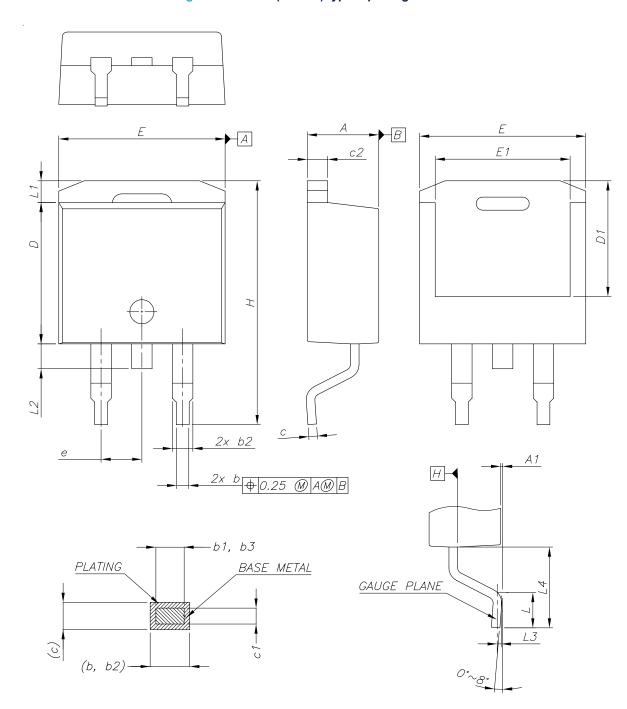
Dim.		mm	
DIM.	Min.	Тур.	Max.
А	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
С	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50	7.75	8.00
D2	1.10	1.30	1.50
E	10.00		10.40
E1	8.50	8.70	8.90
E2	6.85	7.05	7.25
е		2.54	
e1	4.88		5.28
Н	15.00		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.40	
V2	0°		8°

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4.3 D²PAK (TO-263) type B package information

Figure 21. D²PAK (TO-263) type B package outline



0079457_24_B

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Table 10. D²PAK (TO-263) type B mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.36		4.56
A1	0		0.25
b	0.70		0.90
b1	0.51		0.89
b2	1.17		1.37
b3	1.36		1.46
С	0.38		0.694
c1	0.38		0.534
c2	1.19		1.34
D	8.60		9.00
D1	6.90		7.50
Е	10.15		10.55
E1	8.10		8.70
е		2.54 BSC	
Н	15.00		15.60
L	1.90		2.50
L1			1.65
L2			1.78
L3		0.25	
L4	4.78		5.28

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9.75 16.9 2.54 5.08

Figure 22. D²PAK (TO-263) recommended footprint (dimensions are in mm)

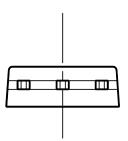
Footprint

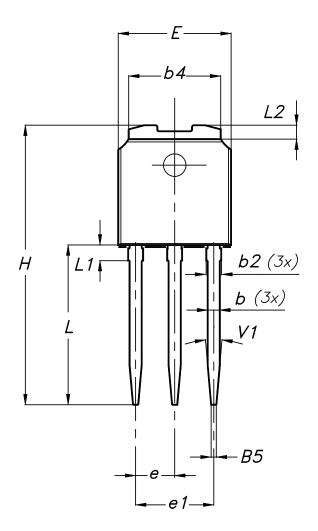
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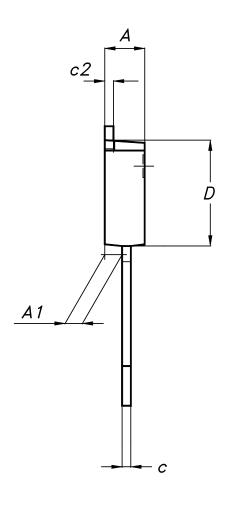


4.4 IPAK (TO-251) type A package information

Figure 23. IPAK (TO-251) type A package outline







0068771_IK_typeA_rev14

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Table 11. IPAK (TO-251) type A package mechanical data

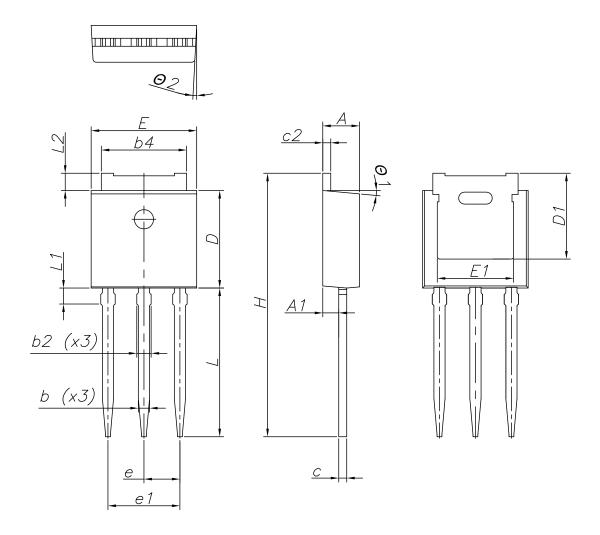
Dim.		mm		
Dilli.	Min.	Тур.	Max.	
A	2.20		2.40	
A1	0.90		1.10	
b	0.64		0.90	
b2			0.95	
b4	5.20		5.40	
B5		0.30		
С	0.45		0.60	
c2	0.48		0.60	
D	6.00		6.20	
E	6.40		6.60	
е		2.28		
e1	4.40		4.60	
Н		16.10		
L	9.00		9.40	
L1	0.80		1.20	
L2		0.80	1.00	
V1		10°		

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4.5 IPAK (TO-251) type C package information

Figure 24. IPAK (TO-251) type C package outline



0068771_IK_typeC_rev14

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Table 12. IPAK (TO-251) type C package mechanical data

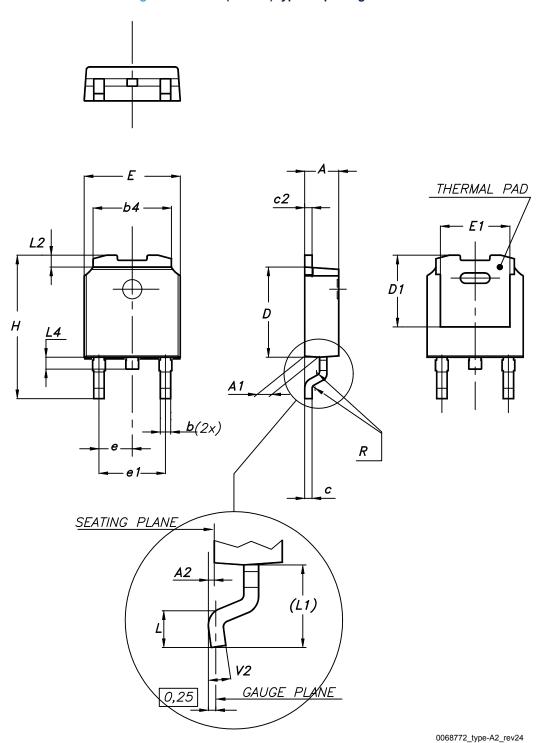
Dim.		mm	
Dim.	Min.	Тур.	Max.
A	2.20	2.30	2.35
A1	0.90	1.00	1.10
b	0.66		0.79
b2			0.90
b4	5.23	5.33	5.43
С	0.46		0.59
c2	0.46		0.59
D	6.00	6.10	6.20
D1	5.20	5.37	5.55
E	6.50	6.60	6.70
E1	4.60	4.78	4.95
е	2.20	2.25	2.30
e1	4.40	4.50	4.60
Н	16.18	16.48	16.78
L	9.00	9.30	9.60
L1	0.80	1.00	1.20
L2	0.90	1.08	1.25
θ1	3°	5°	7°
θ2	1°	3°	5°

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4.6 DPAK (TO-252) type A2 package information

Figure 25. DPAK (TO-252) type A2 package outline



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Table 13. DPAK (TO-252) type A2 mechanical data

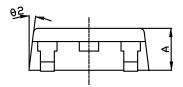
Dim.		mm	
Dim.	Min.	Тур.	Max.
А	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
Е	6.40		6.60
E1	5.10	5.20	5.30
е	2.16	2.16 2.28 2.40	
e1	4.40		4.60
Н	9.35		10.10
L	1.00		1.50
L1	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°

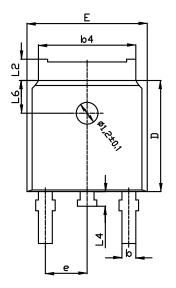
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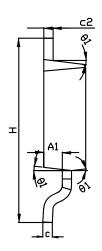


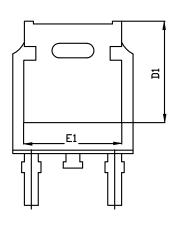
4.7 DPAK (TO-252) type C2 package information

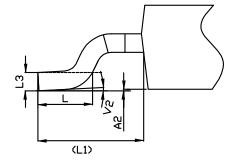
Figure 26. DPAK (TO-252) type C2 package outline











0068772_C2_24

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Table 14. DPAK (TO-252) type C2 mechanical data

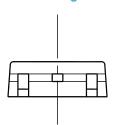
Dim.		mm	
Dim.	Min.	Тур.	Max.
Α	2.20	2.30	2.38
A1	0.90	1.01	1.10
A2	0.00		0.10
b	0.72		0.85
b4	5.13	5.33	5.46
С	0.47		0.60
c2	0.47		0.60
D	6.00	6.10	6.20
D1	5.10		5.60
E	6.50	6.60	6.70
E1	5.20		5.50
е	2.186	2.286	2.386
Н	9.80	10.10	10.40
L	1.40	1.50	1.70
L1		2.90 REF	
L2	0.90		1.25
L3		0.51 BSC	
L4	0.60	0.80	1.00
L6		1.80 BSC	
θ1	5°	7°	9°
θ2	5°	7°	9°
V2	0°		8°

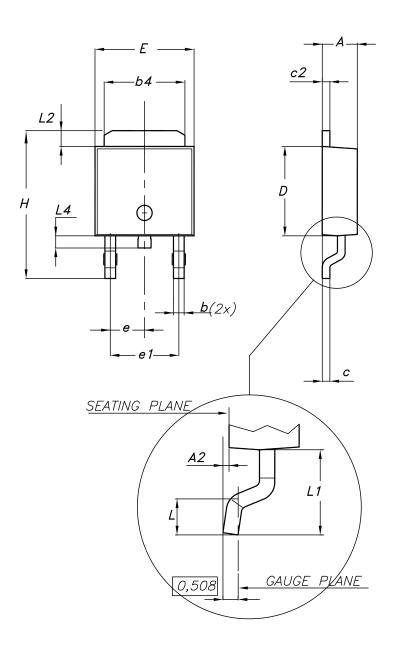
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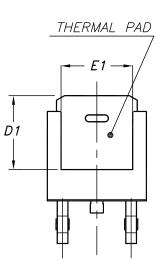


4.8 DPAK (TO-252) type E package information

Figure 27. DPAK (TO-252) type E package outline







0068772_type-E_rev.24

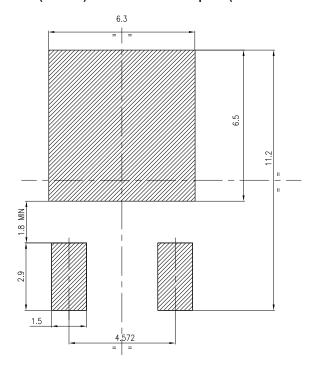
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Table 15. DPAK (TO-252) type E mechanical data

Dim.	mm			
Dilli.	Min.	Тур.	Max.	
A	2.18		2.39	
A2			0.13	
b	0.65		0.884	
b4	4.95		5.46	
С	0.46		0.61	
c2	0.46		0.60	
D	5.97		6.22	
D1	5.21			
Е	6.35		6.73	
E1	4.32			
е		2.286		
e1		4.572		
Н	9.94		10.34	
L	1.50		1.78	
L1		2.74		
L2	0.89		1.27	
L4			1.02	

Figure 28. DPAK (TO-252) recommended footprint (dimensions are in mm)



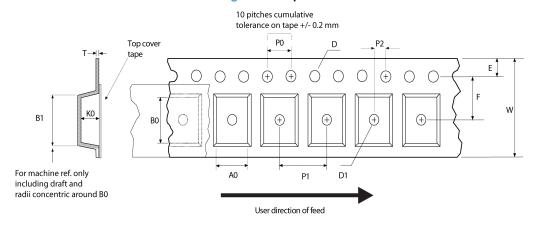
FP_0068772_24

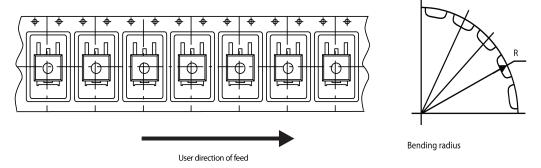
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4.9 D²PAK and DPAK packing information

Figure 29. Tape outline



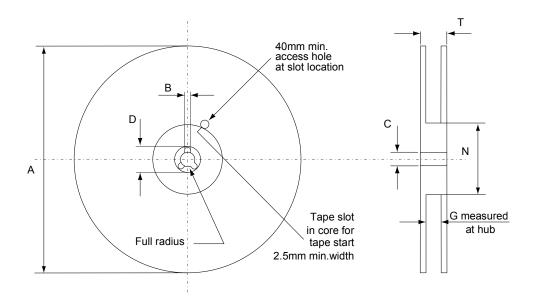


AM08852v1

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Figure 30. Reel outline



AM06038v1

Table 16. D²PAK tape and reel mechanical data

Таре		Reel			
Dim.	n	nm	Dim.	mr	n
Dilli.	Min.	Max.	Dilli.	Min.	Max.
A0	10.5	10.7	А		330
В0	15.7	15.9	В	1.5	
D	1.5	1.6	С	12.8	13.2
D1	1.59	1.61	D	20.2	
E	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	Т		30.4
P0	3.9	4.1			
P1	11.9	12.1	Base quantity		1000
P2	1.9	2.1	Bulk quantity		1000
R	50				
Т	0.25	0.35			
W	23.7	24.3			

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Table 17. DPAK tape and reel mechanical data

Таре			Reel		
Dim.	n	mm			mm
Dim.	Min.	Max.	Dim.	Min.	Max.
A0	6.8	7	А		330
В0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
E	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1	Base qty.		2500
P1	7.9	8.1	Bulk qty.		2500
P2	1.9	2.1			
R	40				
Т	0.25	0.35			
W	15.7	16.3			

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5 Ordering information

Table 18. Order codes

Order code	Marking	Package	Packing
STB4NK60Z-1	B4NK60Z	I ² PAK	Tube
STB4NK60ZT4	DANKOUZ	D ² PAK	Tape and reel
STD4NK60Z-1	D4NK60Z	IPAK	Tube
STD4NK60ZT4	DHINNOUZ	DPAK	Tape and reel

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Revision history

Table 19. Document revision history

Date	Version	Changes
25-Oct-2006	4	Document reformatted no content change.
04-Mar-2008	5	Modified TO-220 and TO-220FP mechanical data.
16-Apr-2008	6	Minor text changes to improve readability.
11-Jul-2011	7	Updated package mechanical data Section 4 and packaging mechanical data Section 4.
18-Jul-2013	8	 Minor text changes The part numbers STP4NK60Z and STP4NK60ZFP have been moved to a separate datasheet Updated: Section 4: Package mechanical data and Section 4: Package mechanical data
05-Apr-2018	9	Removed maturity status indication from cover page. The document status is production data. Updated part numbers. Updated Table 1. Absolute maximum ratings, Table 4. On/off states, Table 5. Dynamic, Table 6. Source-drain diode and Table 7. Gate-source Zener diode. Updated Section 2.1 Electrical characteristics (curves) and Section 4 Package information. Minor text changes.

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